System Overview and Grounding

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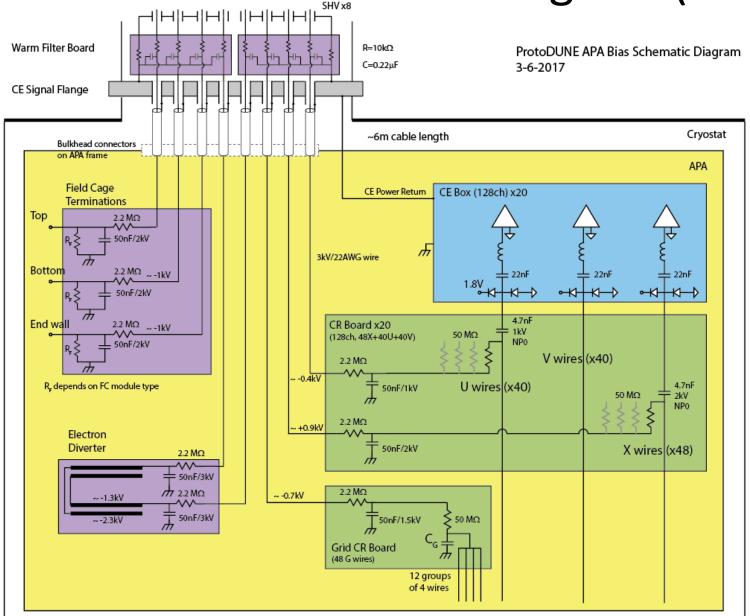
DUNE Electronics Review

2019 November 18





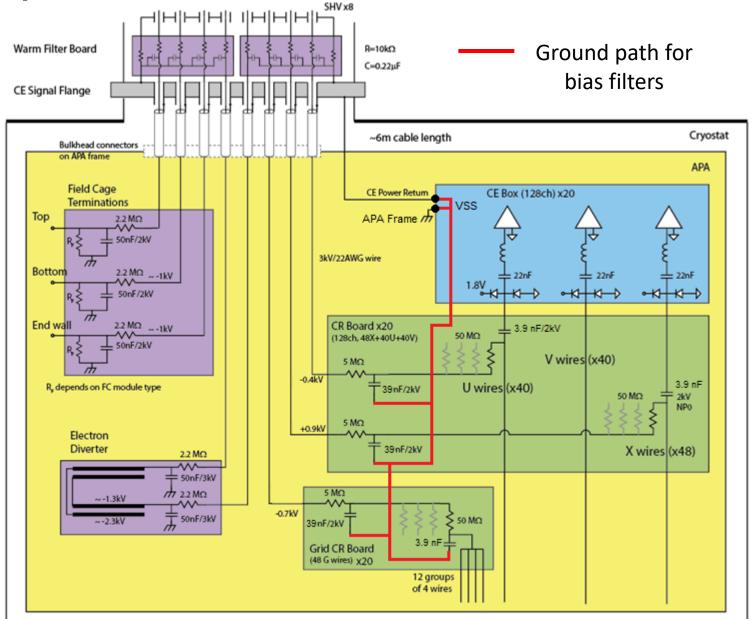
Previous APA Schematic Diagram (Bo's)



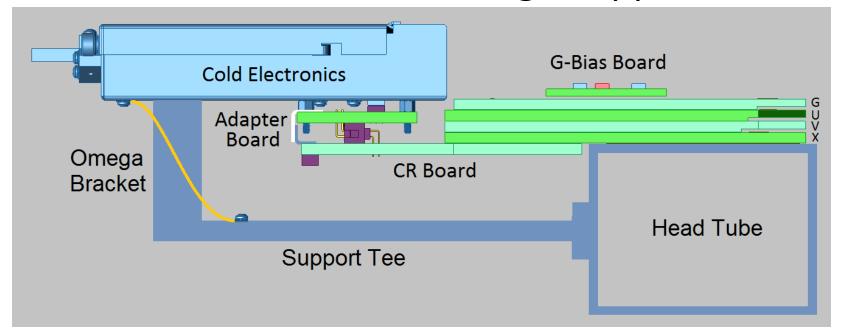
ProtoDUNE Implementation Details

- Single part for coupling and bias-filter caps
 - 3.9 nF +/- 5 percent, 2 kV used throughout
 - Met minimum coupling capacitance requirement
 - Bias filters use ten capacitors in parallel for 39 nF
- All bias filters were grounded through connections to VSS pins on the Cold Electronics Front-End input connectors
- VSS connects to the frame via the CE box

Updated APA Schematic ProtoDUNE



Frame Ground Paths Through Support Tees



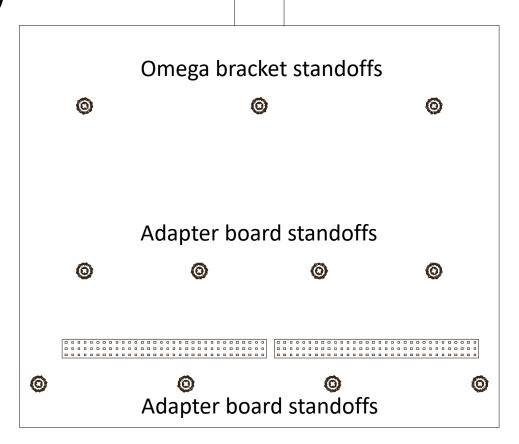
- The power-return wire connects the CE enclosure (and VSS on circuit boards) to the cyrostat wall
- CE enclosures are electrically bonded to the APA frame through omega brackets and ground straps connected to support tees mounted on the head tube

Ground Connections to CE Boxes

CE enclosure outline (side facing CR board)

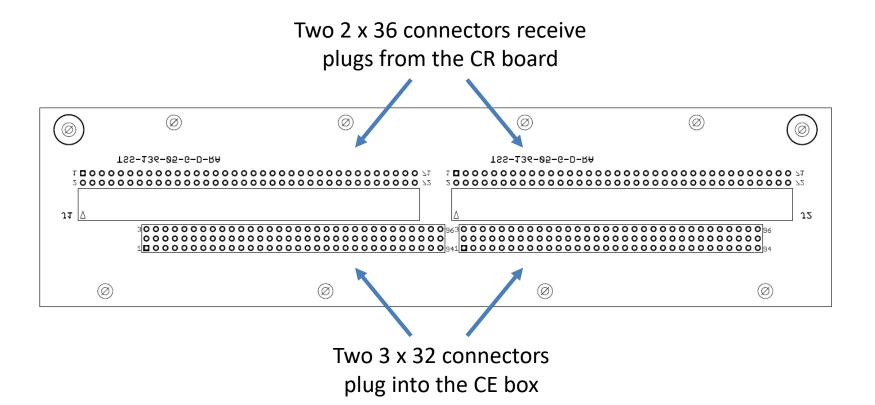
The center row of pins on the front-end input connectors are connected to the VSS power plane.

VSS also connects to the Cold Electronics enclosure.



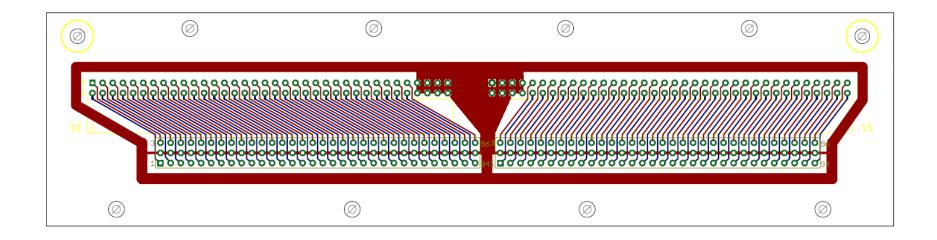
Ground Path Through Adapter Boards

Connections to VSS are carried through Adapter boards

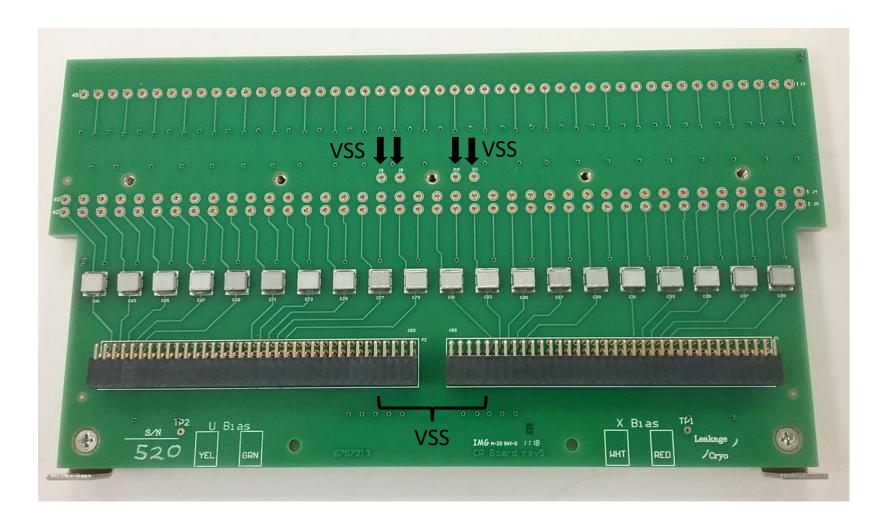


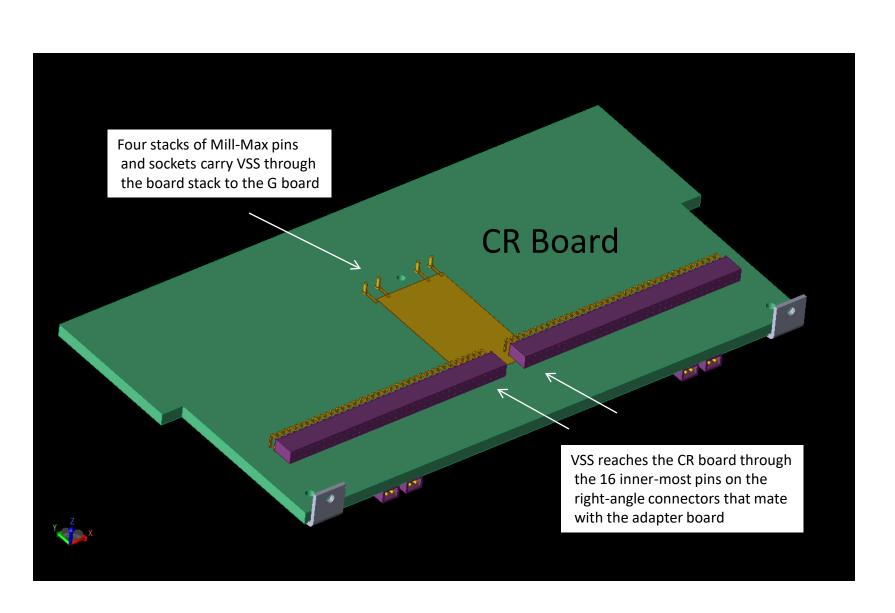
Ground Path Through Adapter Boards

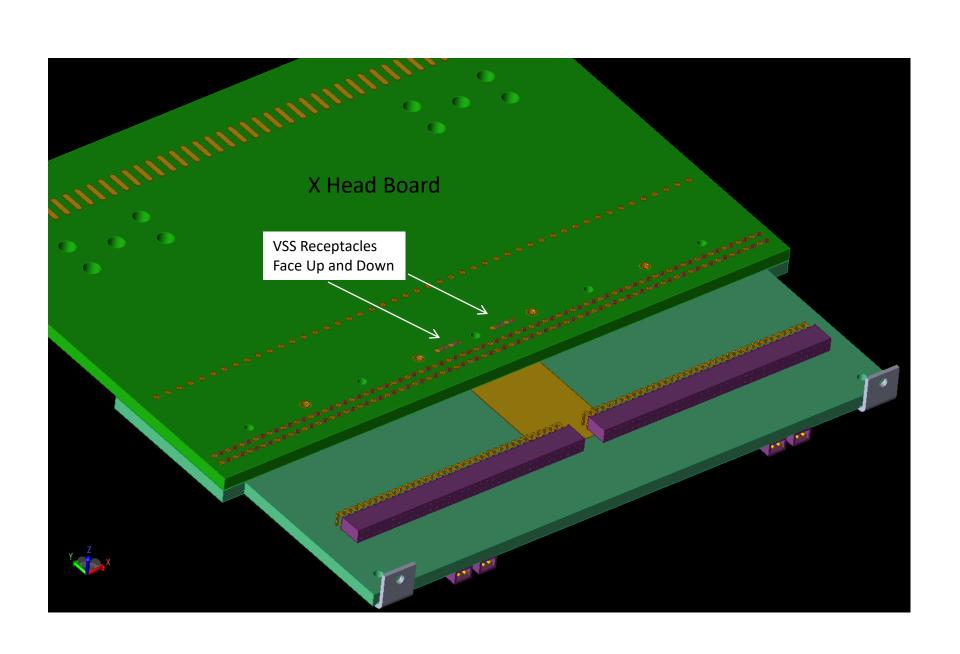
The center row of pins plugged into the CE input connectors are routed to the eight inner-most pins in connectors that mate with the CR board with a "ground pour" for low inductance

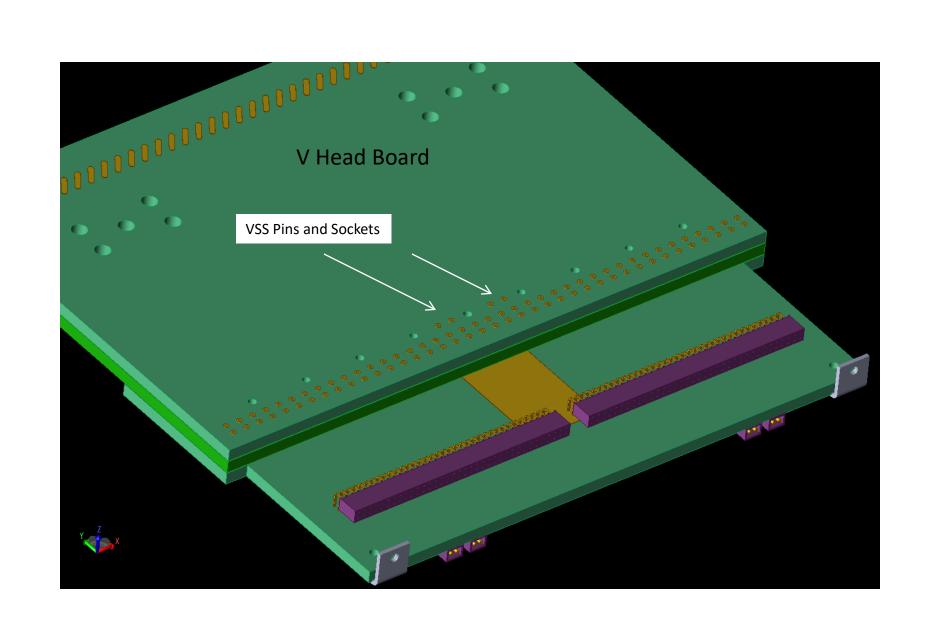


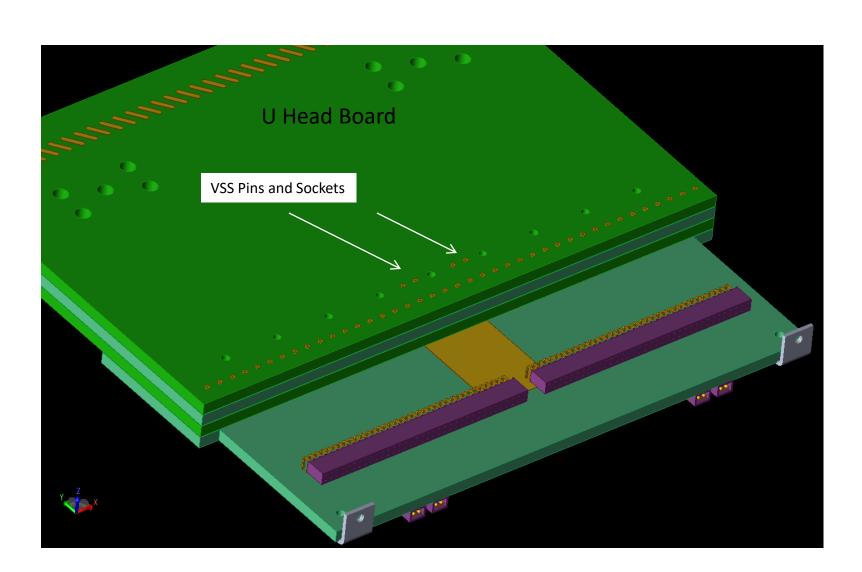
CR boards carry VSS to the board stack

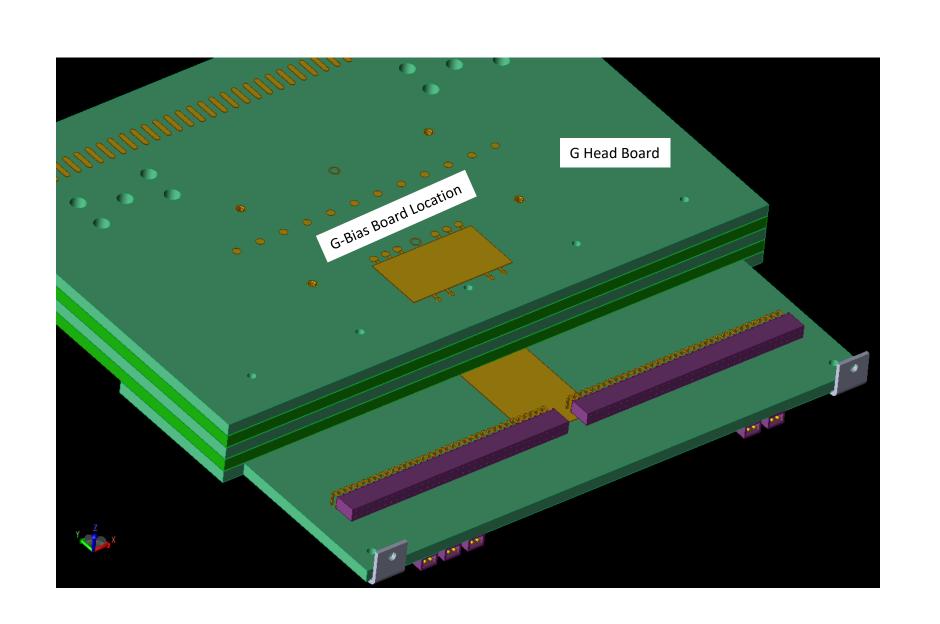


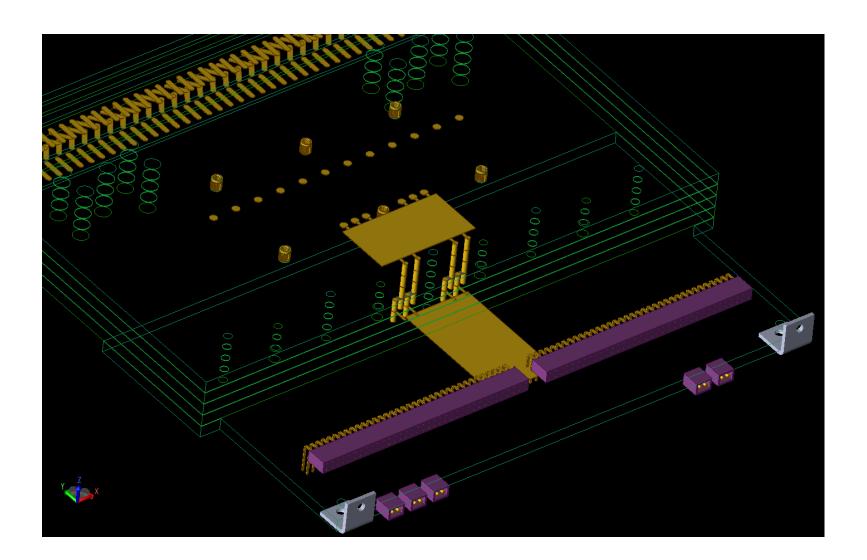




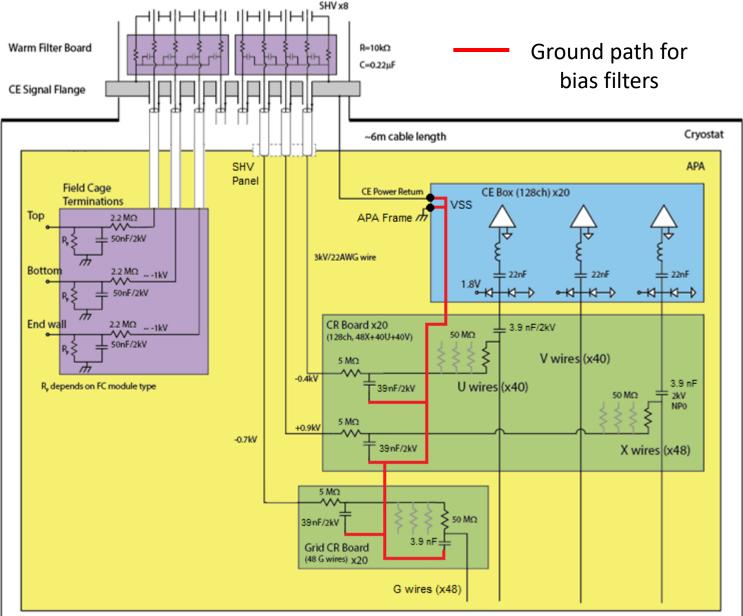




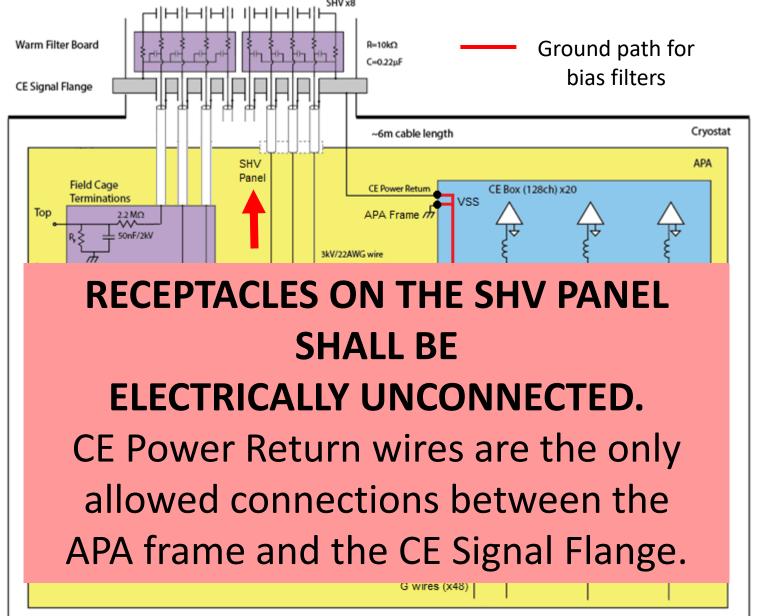




Proposed APA Schematic DUNE



Proposed APA Schematic DUNE



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